

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

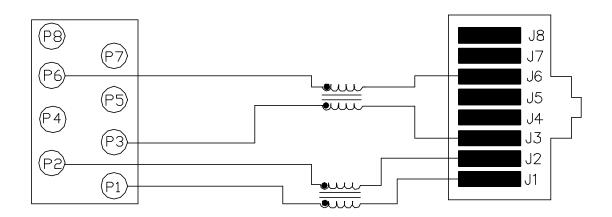
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









ELECTRICAL SPECIFICATIONS:

OPERATING TEMPERATURE RANGE: -20C TO +85C

1.0 INDUCTANCE:

P6-J6=P3-J3 ; P2-J2=P1-J1 : 65 uH 0.1V, 10 KHz, nominal @ 25C.

2.0 DC RESISTANCE:

3.0 COMMON MODE ATTENUATION:

CMA (-dB)

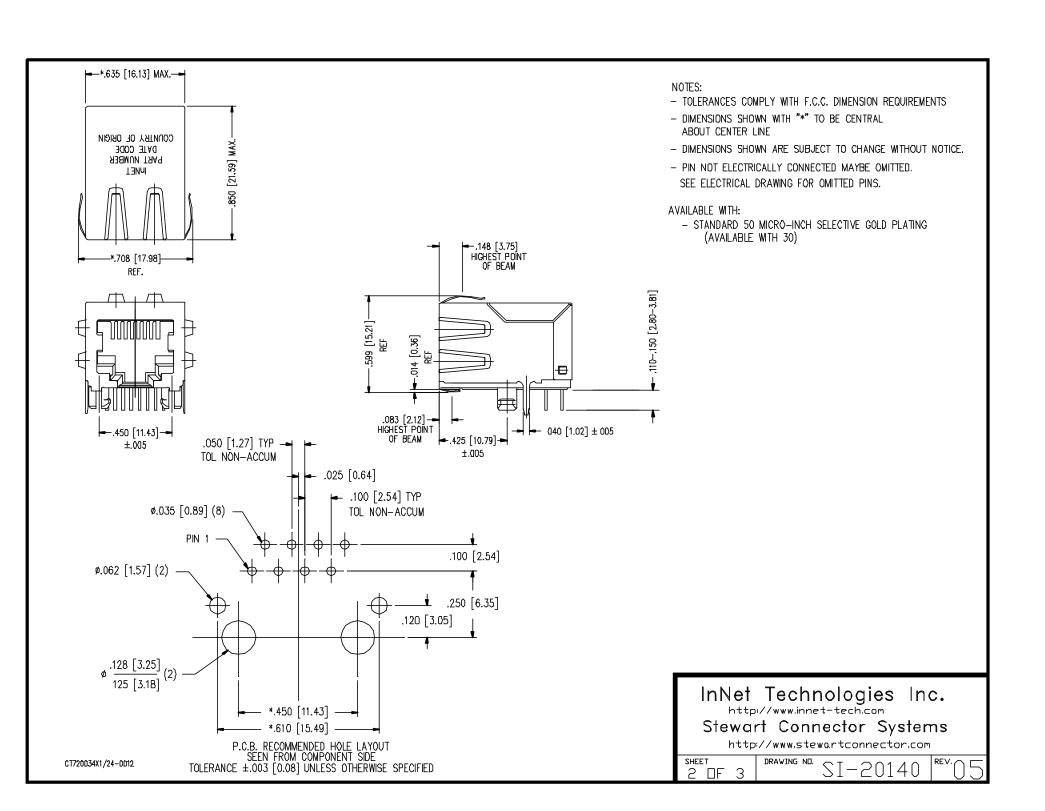
| FREQUENCY (MHz) | TYPICAL | MIN |
|-----------------|---------|-----|
| 1 | 8 | 5 |
| 5 | 17 | 15 |
| 20 | 23 | 15 |
| 70 | 25 | 20 |
| 200 | 22 | 17 |
| 500 | 11 | 6 |
| | | |

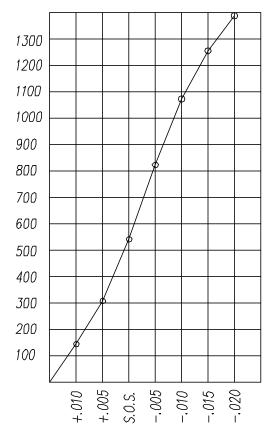
NDTE:

1.0 PINS WITHOUT ELECTRICAL CONNECTIONS ARE OMITTED.

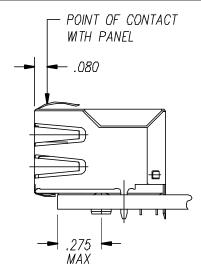
InNet Technologies Inc. http://www.lnnet-tech.com

Stewart Connector Systems
http://www.stewartconnector.com

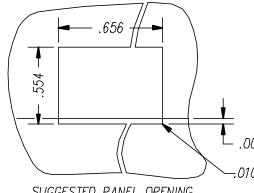




PANEL GROUNDING BEAM DEFLECTION S.O.S. = SUGGESTED OPENING SIZE



THE SUGGESTED PANEL OPENING IS INTENDED TO GIVE THE USER THE ABILITY TO HAVE REASONABLE JACK / PANEL CLEARANCES YFT MAINTAIN RFI IABI F GROUNDING CAPABILITY. THESE VARIABLES CAN BE ADJUSTED IN EITHER DIRECTION BUT MAY CARRY SOME CONSEQUENCES IN THE FORM OF LOWER MATING FORCES OR TIGHTER ASSEMBLY TOLERANCES. FORCE VALUES ON THE GRAPH ARE GENERAL AVERAGES TAKEN AT THE POINT OF CONTACT SHOWN ABOVE. THE SUGGESTED PANEL OPENING INCLUDES APPROXIMATELY .020 CLEARANCE ON THE SIDES AND TOP AND .013 ON THE BOTTOM, AT PANEL OPENING.



.000 (TOP OF PCB TO BOTTOM OF OPENING) -.010 MAX. RADIUS(4)

SUGGESTED PANEL OPENING

CT720034X1/24-001302

InNet Technologies Inc.

http://www.innet-tech.com

Stewart Connector Systems

http://www.stewartconnector.com

SHEET 3 OF 3 DRAWING NO. SI-20140